Plastic NPN Silicon High-Voltage Power Transistors

These devices are designed for use in line-operated equipment such as audio output amplifiers; low-current, high-voltage converters; and AC line relays.

Features

- Excellent DC Current Gain
- High Current-Gain Bandwidth Product
- These Devices are Pb-Free and are RoHS Compliant*

MAXIMUM RATINGS (Note 1)

Rating	Symbol	Value	Unit
Collector–Emitter Voltage 2N5655G 2N5657G	V _{CEO}	250 350	Vdc
Collector–Base Voltage 2N5655G 2N5657G	V _{CB}	275 375	Vdc
Emitter-Base Voltage	V _{EB}	6.0	Vdc
Collector Current – Continuous	I _C	0.5	Adc
Collector Current – Peak	I _{CM}	1.0	Adc
Base Current	I _B	1.0	Adc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	20 0.16	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

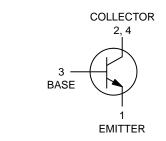
Characteristic	Symbol	Max	Unit	
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	6.25	°C/W	



ON Semiconductor®

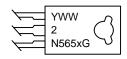
http://onsemi.com

0.5 AMPERE POWER TRANSISTORS NPN SILICON 250-350 VOLTS, 20 WATTS





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
2N5655G	TO-225 (Pb-Free)	500 Units / Bulk
2N5657G	TO-225 (Pb-Free)	500 Units / Bulk

^{1.} Indicates JEDEC registered data.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS ($T_C = 25$ °C unless otherwise noted) (Note 2)

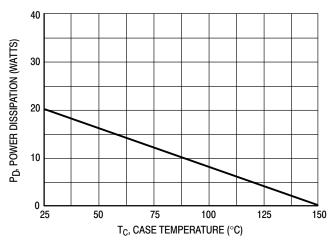
Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS			1	•
Collector–Emitter Sustaining Voltage (I _C = 100 mAdc (inductive), L = 50 mH) 2N5655G 2N5657G	VCEO(sus)	250 350	_ _	Vdc
Collector–Emitter Breakdown Voltage (I _C = 1.0 mAdc, I _B = 0) 2N5655G 2N5657G	V _(BR) CEO	250 350	- -	Vdc
Collector Cutoff Current $(V_{CE} = 150 \text{ Vdc}, I_B = 0)$ 2N5655G $(V_{CE} = 250 \text{ Vdc}, I_B = 0)$ 2N5657G	ICEO	-	0.1	mAdc
Collector Cutoff Current $ (V_{CE} = 250 \text{ Vdc}, V_{EB(off)} = 1.5 \text{ Vdc}) $ $ 2N5655G $ $ (V_{CE} = 350 \text{ Vdc}, V_{EB(off)} = 1.5 \text{ Vdc}) $ $ 2N5657G $ $ (V_{CE} = 150 \text{ Vdc}, V_{EB(off)} = 1.5 \text{ Vdc}, T_{C} = 100^{\circ}\text{C}) $ $ 2N5655G $ $ (V_{CE} = 250 \text{ Vdc}, V_{EB(off)} = 1.5 \text{ Vdc}, T_{C} = 100^{\circ}\text{C}) $ $ 2N5657G $	I _{CEX}	- - -	0.1 0.1 1.0 1.0	mAdc
Collector Cutoff Current $(V_{CB} = 275 \text{ Vdc}, I_E = 0)$ 2N5655G $(V_{CB} = 375 \text{ Vdc}, I_E = 0)$ 2N5657G	Ісво	-	10 10	μAdc
Emitter Cutoff Current (V _{EB} = 6.0 Vdc, I _C = 0)	I _{EBO}	_	10	μAdc
ON CHARACTERISTICS	1		W.	W.
DC Current Gain (Note 3) $ \begin{aligned} &\text{(I}_{\text{C}} = 50 \text{ mAdc, V}_{\text{CE}} = 10 \text{ Vdc)} \\ &\text{(I}_{\text{C}} = 100 \text{ mAdc, V}_{\text{CE}} = 10 \text{ Vdc)} \\ &\text{(I}_{\text{C}} = 250 \text{ mAdc, V}_{\text{CE}} = 10 \text{ Vdc)} \\ &\text{(I}_{\text{C}} = 500 \text{ mAdc, V}_{\text{CE}} = 10 \text{ Vdc)} \end{aligned} $	h _{FE}	25 30 15 5.0	_ 250 _ _	-
Collector–Emitter Saturation Voltage (Note 3) ($I_C = 100 \text{ mAdc}$, $I_B = 10 \text{ mAdc}$) ($I_C = 250 \text{ mAdc}$, $I_B = 25 \text{ mAdc}$) ($I_C = 500 \text{ mAdc}$, $I_B = 100 \text{ mAdc}$)	V _{CE(sat)}	- - -	1.0 2.5 10	Vdc
Base–Emitter Voltage (I _C = 100 mAdc, V _{CE} = 10 Vdc) (Note 3)	V _{BE}	_	1.0	Vdc
DYNAMIC CHARACTERISTICS	<u> </u>			•
Current–Gain – Bandwidth Product (I _C = 50 mAdc, V _{CE} = 10 Vdc, f = 10 MHz) (Note 4)	f⊤	10	_	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 100 kHz)	C _{ob}	-	25	pF
Small–Signal Current Gain (I _C = 100 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz)	h _{fe}	20	_	-

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics for the listed test conditions.

2. Indicates JEDEC registered data for 2N5655 Series.

3. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

4. f_T is defined as the frequency at which |h_{fe}| extrapolates to unity.



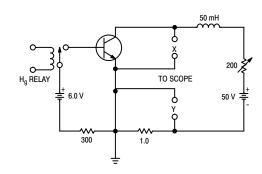
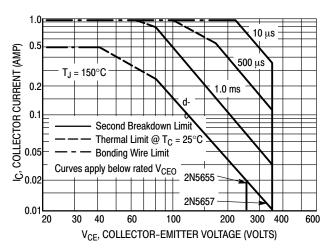


Figure 1. Power Derating

Figure 2. Sustaining Voltage Test Circuit

Safe Area Limits are indicated by Figures 3 and 4. Both limits are applicable and must be observed.



There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C-V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 3 is based on $T_{J(pk)} = 150^{\circ}C$; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}C$. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

Figure 3. Active-Region Safe Operating Area

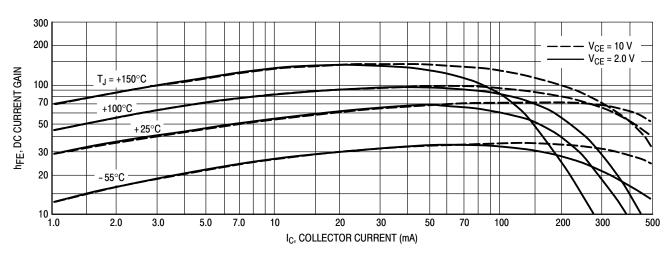


Figure 4. Current Gain

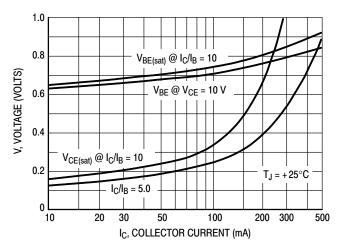


Figure 5. "On" Voltages

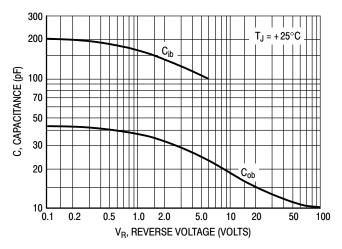


Figure 6. Capacitance

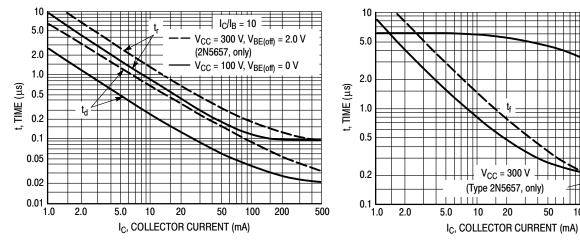


Figure 7. Turn-On Time

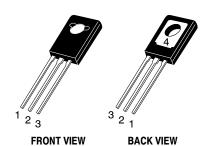
Figure 8. Turn-Off Time

 $I_{\rm C}/I_{\rm B}=10$

V_{CC} = 100 V

500

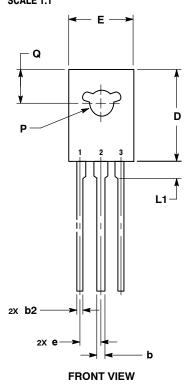


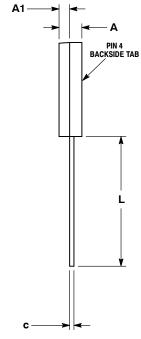


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DATE 25 MAR 2015

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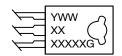


SIDE VIEW

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS. 3. NUMBER AND SHAPE OF LUGS OPTIONAL.

	MILLIMETERS					
DIM	MIN	MAX				
Α	2.40	3.00				
A1	1.00	1.50				
b	0.60	0.90				
b2	0.51	0.88				
С	0.39	0.63				
D	10.60	11.10				
E	7.40	7.80				
е	2.04	2.54				
L	14.50	16.63				
L1	1.27	2.54				
P	2.90	3.30				
Q	3.80	4.20				

GENERIC MARKING DIAGRAM*



= Year ww

= Work Week XXXXX = Device Code = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

,	EMITTER COLLECTOR	2., 4.	CATHODE ANODE		COLLECTOR	2., 4.	ANODE 1 ANODE 2		MT 2
STYLE 6:	BASE	STYLE 7:	GATE	3. STYLE 8:	EMITTER	STYLE 9:	GATE	3. STYLE 10:	GATE
	CATHODE	PIN 1.			SOURCE	PIN 1.			SOURCE
	GATE ANODE	,	GATE MT 2		GATE DRAIN	2., 4.	DRAIN	,	DRAIN GATE

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